

# VS2522AL-VB Datasheet P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY	
V <sub>DS</sub> (V)	- 20
$R_{DS(on)}(\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.034
$R_{DS(on)}(\Omega)$ at $V_{GS} = -2.5 \text{ V}$	0.046
$R_{DS(on)}(\Omega)$ at $V_{GS} = -1.8 \text{ V}$	0.067
I <sub>D</sub> (A)	- 5
Configuration	Single

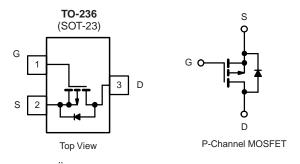
### **FEATURES**

- Halogen-free Option Available
- Trench Power MOSFET

# RoHS COMPLIANT HALOGEN

## **APPLICATIONS**

• Load Switch for Portable Devices



ABSOLUTE MAXIMUM RATING	S (T <sub>C</sub> = 25 °C, unles	s otherwise noted	d)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		$V_{DS}$	- 20	V
Gate-Source Voltage		$V_{GS}$	± 8	V
Continuous Drain Current	T <sub>C</sub> = 25 °C	1	- 5	
Continuous Drain Current	T <sub>C</sub> = 125 °C	- I <sub>D</sub>	- 3	
Continuous Source Current (Diode Conduct	ion)	Is	- 2.5	Α
Pulsed Drain Current <sup>a</sup>		I <sub>DM</sub>	- 20	
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 11	
Single Pulse Avalanche Energy	L = U.1 MIH	E <sub>AS</sub>	6	mJ
Maximum Dawar Dissination?	T <sub>C</sub> = 25 °C	T <sub>C</sub> = 25 °C	14/	
Maximum Power Dissipation <sup>a</sup>	T <sub>C</sub> = 125 °C	$P_{D}$	0.67	VV
Operating Junction and Storage Temperatu	re Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount <sup>b</sup>	$R_{thJA}$	175	°C/W
Junction-to-Foot (Drain)		$R_{thJF}$	75	C/VV

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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static	•	1			ı		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		- 20	-	-	V
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = - 250 μA	- 0.45	-	- 1	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	= 0 V, V <sub>GS</sub> = ± 8 V	-	-	± 100	nA
		$V_{GS} = 0 V$	V <sub>DS</sub> = - 12 V	-	-	- 1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = - 12 V, T <sub>J</sub> = 125 °C	1	-	- 50	μΑ
		$V_{GS} = 0 V$	V <sub>DS</sub> = - 12 V, T <sub>J</sub> = 175 °C	-	-	- 150	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = - 4.5 V	$V_{DS} \le -5 V$	- 10	-	-	Α
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = - 4.5 V	I <sub>D</sub> = - 3.5 A	ı	0.034	1	Ω
		$V_{GS} = -4.5 \text{ V}$	I <sub>D</sub> = - 3.5 A, T <sub>J</sub> = 125 °C	ı	0.066	-	
	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}$	I <sub>D</sub> = - 3.5 A, T <sub>J</sub> = 175 °C	ı	0.075	1	
		$V_{GS} = -2.5 \text{ V}$	I <sub>D</sub> = - 3 A	ı	0.046	1	
		V <sub>GS</sub> = - 1.8 V	I <sub>D</sub> = - 2 A	-	0.067	-	
Forward Transconductanceb	9 <sub>fs</sub>	V <sub>DS</sub> =	- 5 V, I <sub>D</sub> = - 1.6 A	ı	7	ı	S
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			-	695	870	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = - 6 V, f = 1 MHz	ı	265	335	pF
Reverse Transfer Capacitance	C <sub>rss</sub>			ı	190	240	
Total Gate Charge <sup>c</sup>	Qg			-	8.4	13	
Gate-Source Charge <sup>c</sup>	$Q_{gs}$	V <sub>GS</sub> = - 4.5 V	$V_{DS} = -6 \text{ V}, I_{D} = -3.85 \text{ A}$	-	1	-	nC
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			-	2.4	-	
Gate Resistance	$R_g$	f = 1 MHz		4.1	8.2	12.3	Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	17	26	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = -6 \text{ V}, R_L = 1.6 \Omega$ $I_D \cong -3.85 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		-	19	29	- ns
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	28	42	
Fall Time <sup>c</sup>	t <sub>f</sub>			-	13	20	
Source-Drain Diode Ratings and Chara	acteristics <sup>b</sup>						
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			ı	-	- 20	Α
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = - 2 A, V <sub>GS</sub> = 0 V		-	- 0.8	- 1.2	V

#### Notes

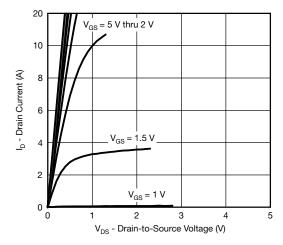
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

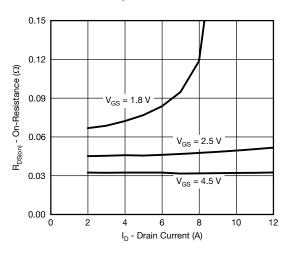
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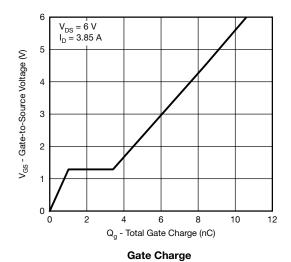
## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \, ^{\circ}\text{C}$ , unless otherwise noted)



#### **Output Characteristics**

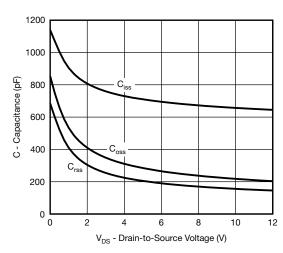


**On-Resistance vs. Drain Current** 

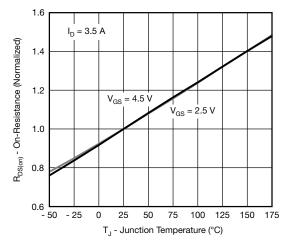


T<sub>C</sub> = 25 °C  $T_{C} = 25$  °C  $T_{C} = -55$  °C

**Transfer Characteristics** 



Capacitance

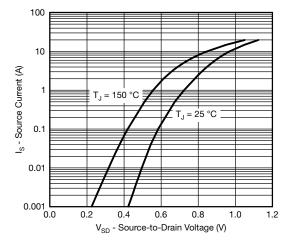


**On-Resistance vs. Junction Temperature** 

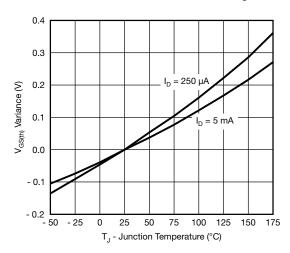
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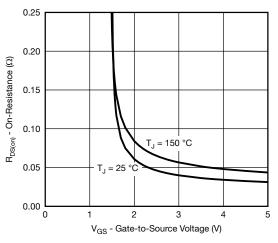
## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \, ^{\circ}\text{C}$ , unless otherwise noted)



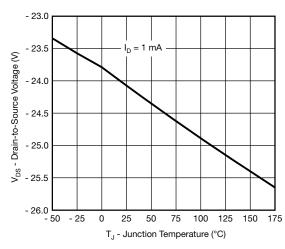
#### Source-Drain Diode Forward Voltage



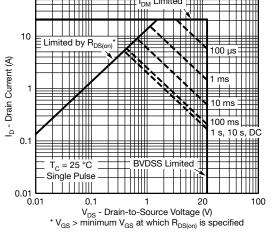
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage



**Drain Source Breakdown vs. Junction Temperature** 

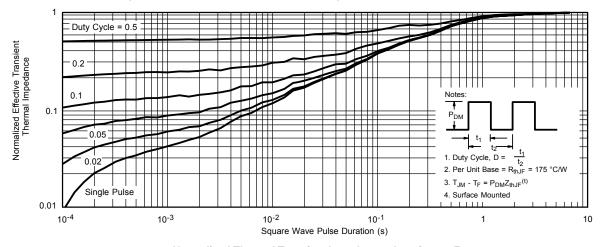


Safe Operating Area

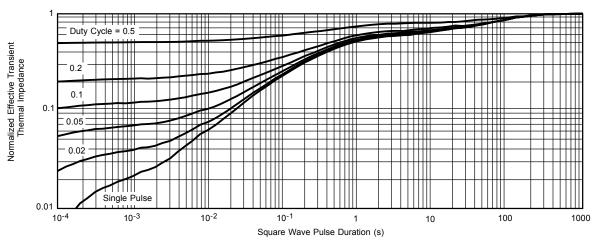
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#### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



### Normalized Thermal Transient Impedance, Junction-to-Foot



Normalized Thermal Transient Impedance, Junction-to-Ambient

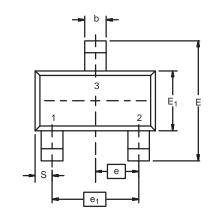
#### Note

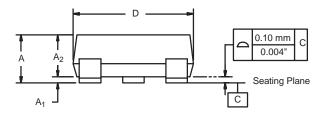
- · The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
  - Normalized Transient Thermal Impedance Junction-to-Foot (25 C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



## SOT-23 (TO-236): 3-LEAD







Dim	MILLIM	IETERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e <sub>1</sub>	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025	Ref	
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	

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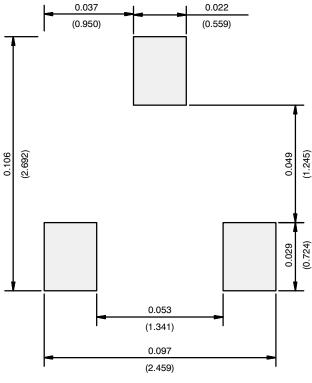
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### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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